MAX32000

High-Speed Quad Driver with Integrated DACs, Cable-Droop Compensation, Slew-Rate Control, and VHH Fourth-Level Drive

General Description

The MAX32000 is a fully integrated, quad-channel, high-performance pin-electronics driver with built-in level-setting DACs, ideal for memory and SOC ATE systems. Each MAX32000 channel includes a four-level pin driver, programmable cable-droop compensation, five 14-bit DACs, and a comparator that is useful for AC calibration.

The driver features a wide -2V to +6V operating range and a data rate of 1200Mbps at +2V operation, and in high-voltage mode (VHH mode) offers an output voltage range of 0 to 13V. The device includes high impedance, active termination (3rd-level drive), and is highly linear even at low voltage swings. The calibration comparators and multiplexer provide a timing calibration path for each channel. A serial interface configures the device, easing PCB signal routing.

The MAX32000 is available in a 64-pin TQFP-EPR package with top-side exposed pad.

Applications

- Memory Testers
- SOC Testers
- Digital Testers
- Discrete Component ATE
- Burn-In Testers
- Wafer Testers

Benefits and Features

- Low Power at High-Speed Maximizes Driver Performance
 - 700mW per Channel
 - 2.57Gbps at +1V Programmed
 - 280ps Typical Rise/Fall Times at +2V (20% to 80%)
 - Very Low Timing Dispersion at 50ps Typical
 - Wide Voltage Range from -2V to +6V
 - Integrated VHH Programming Mode (4th-Level Drive) up to 13V
 - 100nA Low-Leak Mode
- Integrated Functionality Provides Value-Added Features
 - Programmable Double Time Constant Cable-Droop Compensation
 - Digital Slew-Rate Control for EMI-Sensitive Applications
 - Adjustable Output Resistance with $360m\Omega$ Resolution
 - 22 DACs to Generate DC Voltage Levels for Control and Monitoring
 - 50MHz SPI™ Interface

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX32000CCB+	0°C to +70°C	64 TQFP-EP*

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

SPI is a trademark of Motorola, Inc.



^{*}EP = Exposed pad.

Absolute Maximum Ratings

Vcc to GND	0.3V to +11.0V
VEE to GND	6.0V to +0.3V
Any VCC to Any VEE	+16.5V
V _{DD} to DGND	0.3V to +5.0V
V _{HHP} to GND	
DGND to GND	
GNDDAC to GND	
DGND to GNDDAC	±0.3V
DGS to GND	
CTV, DATV_, RTV_ to GND	0.3V to +5V
DATA_, NDATA_ to GND(VEE -	0.3V) to (V _{CC} + 0.3V)
RCV_, NRCV_ to GND(VEE -	0.3V) to (Vcc + 0.3V)
CMP, NCMP to GND (VCTV -	
Current into CMP, NCMP	
DATA_ to NDATA_, RCV_ to NRCV	±1V
DUT_ to GND	
(all modes except VHH)(VEE -	0.3V) to (V _{CC} + 0.3V)
DUT_ to GND (VHH mode)	
DUT to VEE	
SCLK, DIN, CS, LOAD, RST to DGND	

ENVHH to DGND0 OVALARM, TALARM to DGND0 TEMP to GND(VEE - 0	$0.3V$ to $(V_{DD} + 0.3V)$ $0.3V$) to $(V_{CC} + 0.3V)$
(GNDDAC + 2.6	V) and (Vcc + 0.3V)
REF Current	
All Digital Inputs	±30mA
DUT_ Short-Circuit Duration	
Continuous Power Dissipation	
64-Pin TQFP (derate 125mW/°C above +	-70°C)10.0W
Junction Temperature	+150°C
Operating Junction Temperature Range	+40°C to +100°C
Storage Temperature	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C
ESD, Human Body Model:	
All Pins Excluding Below Pins	2.000V
ESD, Human Body Model: DATA_, NDATA_	1.500V
ESD, Human Body Model: RCV_, NRCV_, DA	
Humidity	10% to 90%

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Thermal Characteristics (Note 1)

64 TQFP-EP

Junction-to-Ambient Thermal Resistance (θ_{JA}).......40°C/W Junction-to-Case Thermal Resistance (θ_{JC}).............1°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of <math>\pm 15$ °C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER						
DRIVER DC CHARACTERISTICS	(R _L ≥ 10MΩ,	unless otherwise noted, includes level-sette	r error)			
Output Voltage Range	VDHV_	V _{DLV} _ = -2.0V, V _{DTV} _ = +1.5V	-1.8		+6.0	
	V _{DLV} _	V _{DHV} _ = +6.0V, V _{DTV} _ = +1.5V	-2.0		+5.8	V
	VDTV_	V _{DHV} = +6.0V, V _{DLV} = -2.0V	-2.0		+6.0	
	VDHV_OS	V _{DHV} = +0.125V, V _{DLV} = -2.0V, V _{DTV} = +1.5V			±2	
Output Offset Voltage (Note 2)	VDLV_OS	V _{DLV} _ = +0.125V, V _{DHV} _ = +6.0V, V _{DTV} _ = +1.5V			±2	mV
	V _{DTV} os	V _{DTV} _ = +0.125V, V _{DHV} _ = +6.0V, V _{DLV} _ = -2.0V			±2	

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of <math>\pm 15$ °C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
O 1 - 1 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	V _{DHV} _TC			±75	±500	
Output Voltage Temperature Coefficient (Notes 3, 4)	VDLV_TC			±75	±500	μV/°C
Coefficient (Notes 5, 4)	V _{DTV} _TC			±75	±500	1
Gain (Note 2)	ADHV_	V _{DLV} = -2.0V, V _{DTV} = +1.5V, V _{DHV} = +0.125V and +3.875V	0.999	1	1.001	
	ADLV_	V _{DHV} = +6.0V, V _{DTV} = +1.5V, V _{DLV} = +0.125V and +3.875V	0.999	1	1.001	V/V
	ADTV_	V _{DHV} = +6.0V, V _{DLV} = -2.0V, V _{DTV} = +0.125V and +3.875V	0.999	1	1.001	
Linearity Error, -0.5V to +4.5V (Note 2, 3)		V _{DLV} = -2.0V, V _{DTV} = +1.5V, V _{DHV} = -0.5V to +4.5V		< ±6		m\/
		V _{DLV} = -2.0V, V _{DHV} = +6.0V, V _{DTV} = -0.5V to +4.5V		< ±6		- mV
		V _{DLV} = -2.0V, V _{DTV} = +1.5V, V _{DHV} = -1.75V to +5.125V		< ±12		
Linearity Error, -1.75V to +5.125V (Note 2, 3)		V _{DHV} = +6.0V, V _{DTV} = +1.5V, V _{DLV} = -1.75V to +5.125V		< ±12		mV
		V _{DLV} = -2.0V, V _{DHV} = +6.0V, V _{DTV} = -1.75V to +5.125V		< ±12		
		V _{DLV} = -2.0V, V _{DTV} = +1.5V, V _{DHV} = -1.8V to +6.0V		< ±14		
Linearity Error, Full Range (Note 2, 3)		V _{DHV} = +6.0V, V _{DTV} = +1.5V, V _{DLV} = -2.0V to +5.8V		< ±14		mV
		V _{DLV} = -2.0V, V _{DHV} = +6.0V, V _{DTV} = -2.0V to +6.0V		< ±14		
DHVto-DLV_ Crosstalk		V _{DLV} = -0.5V, V _{DTV} = +1.5V, V _{DHV} = -0.3V and +6.0V			±3	mV
DLVto-DHV_ Crosstalk		V _{DHV} _ = +4.5V, V _{DTV} _ = +1.5V, V _{DLV} _ = -2.0V and +4.3V			±3	mV
DTVto-DLV_ and DHV_ Crosstalk		V _{DHV} _ = +3V, V _{DLV} _ = 0V, V _{DTV} _ = -2.0V and +6.0V			±2	mV
DHVto-DTV_ Crosstalk		V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DHV} = +1.6V and +3.0V			±3	mV
DLVto-DTV_ Crosstalk		V _{DTV} _ = +1.5V, V _{DHV} _ = +3V, V _{DLV} _ = 0V and +1.4V			±3	mV

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of ±15°C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS
Term Voltage Dependence on DATA_		V _{DTV} _ = +1.5V DATA_ = high a	V , V_{DHV} = +3 V , V_{DLV} = 0 V , and low			±2	mV
DC Power-Supply Rejection	PSRR _{DHV}	V _{DHV} = +3V, varied full rang	VCC and VEE independently e	40			
	PSRR _{DLV}	V _{DLV} = 0V, V ₀ varied full rang	CC and VEE independently e	40			dB
	PSRRDTV	V _{DTV} = +1.5V varied full rang	, V _{CC} and V _{EE} independently e	40			
DC Drive Current Limit		When DATA_ = VDUT_ = -2V	high , V _{DHV} _ = +6.0V and	+65		+110	^
		When DATA_ = VDUT_ = +6V	low, V _{DLV} _ = -2.0V and	-110		-65	- mA
DC Output Resistance		RO_ = 0b1000	(Note 5)	46	48	50	Ω
DC Output Resistance Variation (Note 6)			V _{DHV} = +3V, V _{DLV} = 0V, _{DUT} = 1mA, 12mA, 40mA		1	2	
			/ _{DHV_} = +3V, V _{DLV_} = 0V, _{DUT_} = -1mA, -12mA, -40mA		1	2	Ω
Adjustable Output Resistance Range	DRO	RO_ = Fh vs. F RO_ = 8h, reso (see conditions			±2.5		Ω
DRIVER AC CHARACTERISTICS	(R _L = 50 to	GND) (Note 7)					•
Dynamic Drive Current		(Note 8)			±100		mA
			V _{DLV} _ = 0V, V _{DHV} _ = +0.1V		50		
Drive Mode Overshoot		Cable-droop compensation	V _{DLV} _ = 0V, V _{DHV} _ = +1V		12		- %
Drive Wode Overshoot		off	V _{DLV} _ = 0V, V _{DHV} _ = +3V		3.3		
			V _{DLV} _ = 0V, V _{DHV} _ = +5V		2.0		
		0-1-11	V _{DLV} _ = 0V, V _{DHV} _ = +0.1V		20		
Drive Mode Undershoot		Cable-droop compensation	V _{DLV} _ = 0V, V _{DHV} _ = +1V		5		- %
Drive wode Oridershoot		off	V _{DLV} _ = 0V, V _{DHV} _ = +3V		2.3		
			V _{DLV} _ = 0V, V _{DHV} _ = +5V		2.0		
Cable-Droop Compensation		$V_{DLV} = 0V, V_{I}$	DHV_ = +1V, CDRPS_ = 000		0		%
Range, Short Time Constant		$V_{DLV} = 0V, V_{I}$	DHV_ = +1V, CDRPS_ = 111		15		/0
Cable-Droop Compensation			DHV_ = +1V, CDRPL_ = 000		0		%
Range, Long Time Constant		$V_{DLV} = 0V, V_{I}$	DHV_ = +1V, CDRPL_ = 111		15		/0
Driver Cable-Droop Compensation, Short Time Constant					60		ps
Driver Cable-Droop Compensation, Long Time Constant					1.2		ns

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of <math>\pm 15$ °C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		To within 100mV, V _{DHV} = +5V, V _{DLV} = 0V		0.25	1	
Settling Time (Notes 4, 9)		To within 50mV, V _{DHV} = +3V, V _{DLV} = 0V		0.25	1	ns
		To within 25mV, V_{DHV} = +0.5V, V_{DLV} = 0V		0.25	1	
TIMING CHARACTERISTICS (Not	es 7, 10)					
Propagation Delay, Data to Output		V _{DHV} _ = +3.0V, V _{DLV} _ = 0V (Note 11)	0.6	1.0	1.4	ns
Propagation-Delay Match, tLH vs. tHL		(Note 4)		±40	±80	ps
Propagation-Delay Match, Drivers Within Package		Same edge		40		ps
Propagation-Delay Temperature Coefficient		(Note 4)		3	5	ps/°C
Propagation-Delay Change vs. Pulse Width		V _{DHV} _ = +1V, V _{DLV} _ = 0V, 0.85ns to 24.150ns pulse width (Note 4)		±25	±50	
		V _{DHV} = +3V, V _{DLV} = 0V, 1.0ns to 24.0ns pulse width (Note 4)		±35	±60	ps
		V _{DHV} = +5V, V _{DLV} = 0V, 1.5ns to 23.5ns pulse width		±100		
Propagation-Delay Change vs.		V _{DHV} - V _{DLV} = +1V, V _{DHV} = +1V to +4V (using a DC block)		50	60	200
Common Mode (Note 4)		V _{DHV} - V _{DLV} = +1V, V _{DHV} = -1V to +6V (using a DC block)		50	100	- ps
Propagation Delay, Drive to High Impedance, High Impedance to Drive		V _{DHV} _ = +1V, V _{DLV} _ = -1V (Notes 4, 12)	1.5	2.2	2.9	ns
Delay Match, Drive to High Impedance vs. High Impedance to Drive		V _{DHV} _ = +1V, V _{DLV} _ = -1V (Note 13)		±0.35		ns
Delay Match, High Impedance vs. Data		(Note 14)		1.1		ns
Propagation Delay, Drive to Term, Term to Drive		(Notes 4, 14)	1.7	2.5	3.4	ns
Delay Match, Drive to Term vs. Term to Drive		V _{DHV} _ = +3V, V _{DLV} _ = 0V, V _{DTV} _ = +1.5V (Note 15)		±1		ns
Delay Match, Terminate vs. Data		(Note 14)		1.5		ns

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of <math>\pm 15$ °C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		0.2V _{P-P} programmed, V _{DHV} = +0.2V, V _{DLV} = 0V, 20% to 80% (Note 16)		140		
		0.2V _{P-P} programmed, V _{DHV} = +0.2V, V _{DLV} = 0V, 20% to 80% (Note 17)		150		
		1V _{P-P} programmed, V _{DHV} = +1.0V, V _{DLV} = 0V, 10% to 90% (Notes 4, 16)	200	270	400	
		1V _{P-P} programmed, V _{DHV} = +1.0V, V _{DLV} = 0V, 10% to 90% (Note 17)		350		
		1V _{P-P} programmed, V _{DHV} = +1.0V, V _{DLV} = 0V, 20% to 80% (Notes 4, 16)	140	190	275	
Rise and Fall Time		2V _{P-P} programmed, V _{DHV} = +2V, V _{DLV} = 0V, 20% to 80% (Notes 4, 16)	230	280	400	ps
		2V _{P-P} programmed, V _{DHV} = +2V, V _{DLV} = 0V, 20% to 80%, (Note 17)		300		
		3V _{P-P} programmed, V _{DHV} = +3V, V _{DLV} = 0V, 10% to 90%, trim condition (Note 16)	425	550	800	
		3V _{P-P} programmed, V _{DHV} = +3V, V _{DLV} = 0V, 10% to 90% (Note 17)		605		
		5V _{P-P} programmed, V _{DHV} = +5V, V _{DLV} = 0V, 10% to 90% (Notes 4, 16)	650	850	1050	
		5V _{P-P} programmed, V _{DHV} = +5V, V _{DLV} = 0V, 10% to 90% (Note 17)		880		
		0.2V _{P-P} programmed, V _{DHV} = +0.2V, V _{DLV} = 0V, 20% to 80%		±20		
		1VP-P programmed, VDHV_ = +1.0V, VDLV_ = 0V, 10% to 90% (Note 4)		±20	±40	
Rise and Fall Time Matching (Notes 16, 18)		2VP-P programmed, VDHV_ = +2.0V, VDLV_ = 0V, 20% to 80% (Note 4)		±20	±40	ps
		3VP-P programmed, VDHV_ = +3V, VDLV_ = 0V, 10% to 90%		±30	±80	
		5VP-P programmed, VDHV_ = +5V, VDLV_ = 0V, 10% to 90%		±50		
Slew Rate, Relative to SC1 = SC0 = 0 (Note 19)		SC1 = 0, SC0 = 1, V _{DHV} _ = +3V, V _{DLV} _ = 0V, 20% to 80%		75		
		SC1 = 1, SC0 = 0, V _{DHV} _ = +3V, V _{DLV} _ = 0V, 20% to 80%		50		%
		SC1 = 1, SC0 = 1, V _{DHV} _ = +3V, V _{DLV} _ = 0V, 20% to 80%		25		

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of <math>\pm 15$ °C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		0.2VP-P programmed, V _{DHV} = +0.2V, V _{DLV} = 0V (Note 20)		400		
Minimum Pulse Width (Positive or Negative)		1V _{P-P} programmed, V _{DHV} = +1V, V _{DLV} = 0V (Notes 4, 20)		475	610	
		1V _{P-P} programmed, V _{DHV} = +1V, V _{DLV} = 0V; output reaches at least 90% of its nominal DC output level (Note 4)		390	525	ps
(1 oslave of regulive)		2V _{P-P} programmed, V _{DHV} = +2V, V _{DLV} = 0V (Notes 4, 20)		665	833	
		3V _{P-P} programmed, V _{DHV} = +3V, V _{DLV} = 0V (Notes 4, 20)		800	1000	
		5V _{P-P} programmed, V _{DHV} = +5V, V _{DLV} = 0V (Note 20)		1300		
		0.2V _{P-P} programmed, V _{DHV} = +0.2V, V _{DLV} = 0V (Note 21)		2500		
		1V _{P-P} programmed, V _{DHV} = +1V, V _{DLV} = 0V (Notes 4, 21)	1650	2100		
Data Rate		1V _{P-P} programmed, V _{DHV} = +1V, V _{DLV} = 0V; output reaches at least 90% of its nominal DC output level (Note 4)	1910	2570		Mbps
		2V _{P-P} programmed, V _{DHV} = +2V, V _{DLV} = 0V (Notes 4, 21)	1200			
		3V _{P-P} programmed, V _{DHV} = +3V, V _{DLV} = 0V (Notes 4, 21)	1000			
		5V _{P-P} programmed, V _{DHV} = +5V, V _{DLV} = 0V (Note 21)		900		
Rise and Fall Time, Drive to Term		V _{DHV} = +3V, V _{DLV} = 0V, V _{DTV} = +1.5V, measured 10% to 90% of waveform (Note 22)	250	700	1300	ps
Rise and Fall Time, Term to Drive		V _{DHV} _ = +3V, V _{DLV} _ = 0V, V _{DTV} _ = +1.5V, measured 10% to 90% of waveform (Note 22)	400	550	800	ps
COMPARATOR						
COMPARATOR DC CHARACTER	ISTICS	1				
Input Voltage Range		(Note 23)	-2.2		+6.2	V
Input Offset Voltage		V _{DUT} _ = +0.125V (Note 24)		±1	±5	mV
Input-Voltage Temperature Coefficient		(Notes 24, 25)		±50		μV/°C
Common-Mode Rejection	CMRR	V _{DUT} _ = -2.0V, +6.0V (Notes 24, 26)	50	55		dB

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of ±15°C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		-1.75V to +5.125V, V _{DUT} = -1.75V to +5.125V		< ±8		
Linearity Error (Notes 24, 27)		Full range, V _{DUT} = -2V to +6.0V		< ±10		mV
		Full range, V _{DUT} = -2.2V to +6.2V		< ±12		
Power-Supply Rejection	PSRR	V _{DUT} _ = -2.0V and +6.0V (Notes 24, 28)	50	60		dB
COMPARATOR AC CHARACTERI	STICS (Note	es 29–32)				
Effective Comparator Bandwidth, Term Mode		(Notes 4, 33)	2.0	4.0		GHz
Effective Comparator Bandwidth, High-Impedance Mode		(Note 34)		800		MHz
Minimum Pulse Width		(Notes 4, 35)		0.5	0.65	ns
Propagation Delay			0.35	0.9	1.5	ns
Propagation-Delay Temperature Coefficient				1.7		ps/°C
Channel-to-Channel Propagation- Delay Match, High/High vs. Low/ Low				15		ps
PROPAGATION-DELAY DISPERS	IONS					
Propagation-Delay Dispersion vs. Common-Mode Input		V _{CM} = -1.9V to +5.9V (Notes 4, 36)		40	55	ps
Propagation-Delay Dispersion vs. Duty Cycle		0.6ns to 24.4ns pulse width, relative to 12.5ns pulse width, (Notes 4, 37)		±25	±45	ps
Propagation-Delay Dispersion vs. Slew Rate		1.0V/ns to 6.0V/ns, relative to 2.0V/ns (Note 4)		±30	±40	ps
		Driver in term mode, peak-to-peak within 100mV < V _{CMPV} < 900mV window		50	80	
Waveform Tracking (Notes 4, 38)		Driver in term mode, peak-to-peak within 50mV < VCMPV < 950mV window		80	130	ps
		Driver in high impedance, peak-to-peak within 100mV < VCMPV < 900mV window		150	200	ps
LOGIC OUTPUTS CMP, NCMP (CI	MP, NCMP co	ollector output, $R_L = 50\Omega$ internal pullup to C	TV) (Note	⊋ 39)		
Termination Voltage CTV		External termination voltage	0	1.2	3.5	V
CTV Current		Total current for user-supplied termination voltage		12	14	mA
Output High Voltage			VCTV - 0.1	VCTV - 0.02	VCTV + 0.05	V
Output Low Voltage			VCTV - 0.45	VCTV - 0.3	VCTV - 0.25	V

Electrical Characteristics (continued)

(VCC = ± 9.25 V, VEE = ± -5.25 V, VHHP = ± 17.5 V, VDD = ± 3.3 V, VDHV_ = ± 3 V, VDTV_ = ± 1.5 V, VDLV_ = ± 0 V, VDATV_ = ± 0 V, VDAT

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output-Voltage Swing			250	300	350	mV
Output Termination Resistor			47		53	Ω
Differential Rise Time		10% to 90% (Notes 4, 32)		210	400	ps
Differential Fall Time		10% to 90% (Notes 4, 32)		210	400	ps
TEMPERATURE MONITOR						
Nominal Voltage		T _J = +70°C, R _L ≥ 10MΩ		3.43		V
Nominal Voltage Variation		T _J = +125°C, R _L ≥ 10MΩ, one standard deviation		±50		mV
Temperature Coefficient				10		mV/°C
Output Resistance				22		kΩ
High-Impedance Leakage Current		VTMPSNS = +4V, TSMUX0 = 0			1	μA
TEMPERATURE COMPARATOR/A	LARM					
Comparator Hysteresis				0		mV
Alarm Threshold				+125		°C
Temperature Alarm Accuracy				±5		°C
DIGITAL I/O						
DIFFERENTIAL CONTROL INPUT	S (DATA_, N	DATA_, RCV_, NRCV_)	-			
Input High Voltage	VIH	Functional test	+0.2		+3.5	V
Input Low Voltage	VIL	Functional test	-0.2		+3.1	V
Differential Input Voltage		Functional test	±0.15		±1.0	V
Differential Termination Resistance		Differential termination between DATA_/ NDATA_ and RCV_/NRCV_, tested at ±4mA	96		104	Ω
SINGLE-ENDED INPUTS (CS, SCI	LK, DIN, RS1	1				
Input High			2/3 x V _{DD}		V _{DD}	V
Input Low			-0.1		1/3 x V _{DD}	V
Input Bias Current					±25	μA
SINGLE-ENDED OUTPUT (DOUT)						
High Output	Voн	I _{OH} = 25μA	V _{DD} - 0.15			V
Low Output	VoL	I _{OL} = -25μA			V _{DGND} + 0.15	V
SINGLE-ENDED OPEN-DRAIN OL	JTPUTS (OV	ALARM, TALARM with external 1kΩ to V _{DD})				
Voltage Range	Vvoc		V _{DD} - 0.3		V _{DD} + 0.3	V
Low Output	VoL		VDGND		Vvoc - 1.0	V

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of ±15°C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SERIAL-PORT TIMING (See Figur	e 3)					,
SCLK Frequency					50	MHz
SCLK Pulse-Width High	tсн		10			ns
SCLK Pulse-Width Low	tCL		10			ns
CS Low to SCLK High Setup	tcss0		4.25			ns
SCLK High to CS Low Hold	tCSH0		4.25			ns
CS High to SCLK High Setup	tcss1		4.25			ns
SCLK High to CS High Hold	tCSH1		4.25			ns
DIN to SCLK High Setup	t _{DS}		4.25			ns
DIN to SCLK High Hold	tDH		4.25			ns
CS High Pulse Width	tcswh		40			ns
LOAD Low Pulse Width	t _{LDW}		20			ns
RST Low Pulse Width	trst		25			ns
CS High to LOAD Low Hold	tCSHLD		50			ns
SCLK to DOUT Delay	t _{DO}				62.4	ns
COMMON FUNCTIONS (VCC = +9.	.25V, V _{EE} =	-5.25V, V _{DD} = +3.3V, V _{HHP} = +17.5V, unless of	therwise	noted)		
Operating Voltage Range			-2.0		+13	V
	1	V _{CMPV} = +6.0V, V _{DUT} = -2.0V, CMP_EN = high			±50	
High-Impedance Mode Leakage	IDUT	V _{CMPV} = -2.0V, V _{DUT} = +6.0V, CMP_EN = high			±50	- μΑ
Low-Leak Mode Leakage	IDUT	V _{DUT} _ = -2.0V and +6.0V (Note 40)			±100	nA
O		Driver in terminate mode (Note 4)		0.5	1.0	
Combined Capacitance		Driver in high impedance		3		pF
Low-Leak Enable Time		CS high for setting LLEAKS_ high to IDUT_ specification		20		μs
Low-Leak Disable Time		CS high for setting LLEAKS_ low to normal operation		20		μs
Low-Leak Spike, V _{DLV} _/Leak		V _{DLV} _ = 0V, Z _L = 10MΩ 8pF to GND (Note 4)	-200		+600	mV
Low-Leak Spike, V _{DHV} _/Leak		V_{DHV} = +2V, Z_L = 10M Ω 8pF to GND (Note 4)	-200		+350	mV
Low-Leak Spike, High-Impedance/ Leak		$R_L = 50\Omega$ to GND (Note 4)	-125		+350	mV
DUT_ OVERVOLTAGE ALARM						
Maximum Programmable OVHV			6.7	7.0		V
Minimum Programmable OVLV				-3.0	- 2.7	V

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of ±15°C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Voltage Accuracy		Includes gain, offset, and linearity errors over full alarm range, VOVHV = +6.7V and VOVLV = -2.7V			150	mV
Comparator Delay		With 50mV overdrive on DUT_ signal		390		ns
Comparator Hysteresis				7		mV
Minimum Alarm Setting Voltage	Vovhv - Vovlv			2		V
POWER SUPPLIES						•
Positive Supply	Vcc		9.0	9.25	10.0	V
Negative Supply	VEE		-5.35	-5.25	-4.75	V
Logic Supply	V _{DD}		2.3	3.3	3.6	V
High Voltage Supply	VHHP		17	17.5	18	V
Positive Supply Current	Icc	(Note 41)		180	230	mA
Negative Supply Current	IEE	(Note 41)		210	270	mA
Logic Supply Current	I _{DD}	(Note 41)		11	20	mA
High-Voltage Supply Current	L	(Note 41)		2.0	4.0	
	Інн	VHH mode, all channels enabled (Note 41)		60	70	mA
Dawar Discination		V _{CC} = +9.25V, V _{EE} = -5.25V, V _{DD} = +3.3V, V _{HHP} = +17.5V, LLEAKS_ = 0, CMP_EN = 0, ENVHH = high, ENVHHS_ = 0		0.7	0.8	\\\(C _{2}
Power Dissipation		V _{CC} = +9.25V, V _{EE} = -5.25V, V _{DD} = +3.3V, V _{HHP} = +17.5V, LLEAKS_ = 0, CMP_EN = 1, ENVHH = high, ENVHHS_ = 0		0.74	0.90	- W/Ch
ANALOG INPUTS (DUT_ ground	sense)					
		Relative to GNDDAC, under the full DAC range (Note 42)		<±250		mV
Input Range	V _D GS	Relative to GNDDAC, under the limited DAC range of -1.5V to +5.5V, for VHH the DAC range is limited to 0.5V to 12.25V (Note 43)		<±750		mV
Input Bias Current		V _{DGS} = 0V	-10		+10	μA
0-:		DGS gain for DHV_, DLV_, DTV_, CMPV	1±2%		- V/V	
Gain		DGS gain for VHH		1±3%		
2.5V REFERENCE						
Nominal Voltage	VREF			2.5		V
Input Bias Current			-10		+10	μA

Electrical Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of ±15°C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER VHH DC CHARACTERIS	TICS		•			
Output Voltage Range VVHH		DGS = AGND; for DGS ≠ AGND, refer to the DGS gain specification	0		13	V
DC Output Valtage		V _{VHH} = +13V, I _{DUT} = 10mA		12.45		V
DC Output Voltage		V _{VHH} = 0V, I _{DUT} = -10mA		0.55	0.75	V
Current Limit		V_{VHH} = +13V, V_{DUT} = 0V and V_{VHH} = 0V, V_{DUT} = +13V	±12		±27	mA
Offset Voltage		V _V HH = +7.75V			±30	mV
Output-Voltage Temperature Coefficient	VVHH_TC	(Note 3)		±75	±500	μV/°C
Normalized Gain		V _{VHH} = +7.75V, +12.75V	0.998	1.000	1.002	V/V
Linearity Relative to +7.75V, +12.75V		V _{VHH} = +7.0 to +13.0V			±14	mV
Linearity Relative to +1.5V, +12.75V		V _{VHH} = 0.0V to +13.0V			±30	mV
Output Resistance		I _{DUT} = ±2mA, V _{VHH} = +1V	45	55	75	Ω
Power-Supply Rejection Ratio		VCC, VEE, VHHP independently varied over their allowed ranges		20		mV/V
DRIVER VHH AC CHARACTERIS	ΓICS (RL ≥ 1	0MΩ, C _{DUT} = 100pF)				
VHH Rise/Fall Times		V _{DHV} = +3V, V _{VHH} = +13V, 10% to 90%			250	ns
VHH Overshoot		V _{DHV} = +3V, V _{VHH} = +13V (Note 3)			180	mV
LEVEL DACs						
Settling Time		Full-scale transition to within 5mV		20		μs
		All levels not shown below, 1 LSB = 610μV		< ±1		
Differential Nonlinearity		VHH		< ±2		mV
		OVHV, OVLV		< ±39		

- Note 2: V_{DHV}, V_{DLV}, and V_{DTV} levels are calibrated for gain at +0.125V and +3.875V and are calibrated for offset at +0.125V; relative to straight line between +0.125V and +3.875V.
- Note 3: Change in level over operating range. Includes both gain and offset temperature effects. Simulated over entire +40°C to +100°C junction operating range. Verified at worst-case points, which are at the endpoints V_{DHV} V_{DLV} R 200mV.
- Note 4: Guaranteed by design and characterization.
- Note 5: DATA_ = high, V_{DHV} = 3V, V_{DLV} = 0V, V_{DTV} = 1.5V, I_{OUT} = ±30mA. Nominal target value is 48Ω.
- Note 6: Resistance measurements are made using ±2.5mA current changes in the loading instrument about the noted value. Absolute value of the difference in measured resistance over the specified range, tested separately for each current polarity. Test conditions at IDUT are ±1mA, ±12mA, and ±40mA, respectively.
- Note 7: Rise time of the differential inputs DATA_ and RCV_ is 150ps (10% to 90%). SC1 = SC0 = 0, 40MHz, unless otherwise specified.
- Note 8: Current supplied for a minimum of 10ns. Verified to be greater than or equal to DC drive current by design and characterization.
- Note 9: Measured from the 90% point of the driver output (relative to its final value) to the waveform settling to within the specified limit.
- Note 10: Propagation delays are measured from the crossing point of the differential input signals to the 50% point of expected output swing.
- Note 11: Average of the two measurements for propagation delay, tLH and tHL.
- Note 12: Average of the four measurements in propagation delay, drive to high impedance, and high impedance to drive (t_{LZ}, t_{HZ}, t_{ZL}, and t_{ZH}). Measured from crossing point of RCV_/NRCV_ to 50% point of the output waveform.

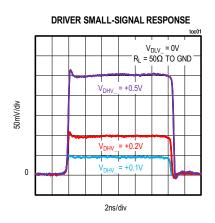
Electrical Characteristics (continued)

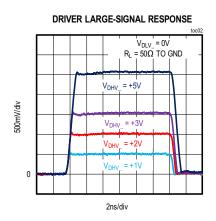
 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = 0V, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC_ = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included. The device is tested at T_J = +70°C with an accuracy of ±15°C; specification compliance with supply and temperature variations are verified by guardbanding mean shifts of characterized data, unless otherwise noted. Temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

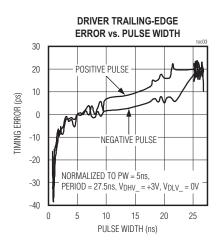
- Note 13: Four measurements are made: V_{DHV} to high impedance, V_{DLV} to high impedance, high impedance to V_{DHV}, and high impedance to V_{DLV} (t_{LZ}, t_{HZ}, t_{ZL}, and t_{ZH}). The worst-case difference is calculated.
- Note 14: Average of the four measurements in propagation delay, drive to term, and term to drive (t_{LT}, t_{HT}, t_{TL}, and t_{TH}). Measured from the crossing point of RCV_/NRCV_ to the 50% point of the output waveform.
- **Note 15:** Four measurements are made: V_{DHV} to V_{DTV}, V_{DLV} to V_{DTV}, V_{DTV} to V_{DHV}, and V_{DTV} to V_{DLV} (t_{LT}, t_{HT}, t_{TL}, and t_{TH}). The worst-case difference is calculated.
- Note 16: Cable-droop compensation disabled. Measured as close as possible to DUT using a high-bandwidth cable.
- Note 17: Cable-droop compensation enabled. Measured at end of 2m RG174 cable.
- Note 18: There should not be a systemic mismatch in rise vs. fall time or tLH vs. tHL.
- Note 19: Functionally tested during production.
- **Note 20:** At this pulse width, the output reaches at least 95% of its nominal (DC) amplitude. The pulse width is measured at the DATA_ (input) pins.
- Note 21: Maximum data rate in transitions/second. A waveform that reaches at least 95% of its programmed amplitude can be generated at one-half of this frequency.
- Note 22: This specification is indicative of switching speed from V_{DHV} or V_{DLV} to V_{DTV} and V_{DTV} to V_{DHV} or V_{DLV} when V_{DLV} < V_{DTV} < V_{DHV} . If V_{DTV} < V_{DLV} or V_{DTV} > V_{DHV} , switching speed is degraded by roughly a factor of 3.
- Note 23: The comparator tolerates the VHH level produced by the driver, but the specifications only apply for the -2.2V to +6.2V input voltage range.
- Note 24: Measured by using a servo to locate comparator thresholds.
- **Note 25:** Change in offset at any voltage over operating range. Includes both gain (CMRR) and offset temperature effects. Simulated over entire operating range. Verified at worst-case points, which are at the endpoints.
- Note 26: Change in offset voltage over input range.
- Note 27: Relative to straight line between +0.125V and +3.875V.
- Note 28: Change in offset voltage with power supplies independently varied over their full range.
- Note 29: All propagation delays measured from VDUT_ crossing calibrated VCMPV threshold to crossing point of differential outputs.
- Note 30: All AC specifications are measured with the DUT_ pin (comparator input) as the reference.
- Note 31: 40MHz, 0 to +2V input to comparator, V_{CMPV} reference = +1.0V, 50% duty cycle 1ns rise/fall time, Zs = 50Ωs, driver in term mode with V_{DTV} = +1.0V, unless otherwise noted.
- **Note 32:** Use calibration comparator per channel and avoid any transition on deselected channel. If transitions cannot be avoided, keep deselected channels in low-leak mode to minimize coupling during calibration.
- Note 33: Input rise/fall time = 45ps. 0 to 1.0V, 50% duty cycle.
- Note 34: Input rise/fall time = 150ps. 0 to 1.0V, 50% duty cycle.
- **Note 35:** At this pulse width, the output reaches at least 90% of its nominal peak-to-peak swing. The pulse width is measured at the crossing points of the differential outputs. 500ps rise/fall time. Timing specifications are not guaranteed.
- Note 36: V_{DUT} = 200mV_{P-P}, rise/fall time = 250ps, overdrive = 100mV, V_{DTV} = V_{CM}. Valid for a common-mode range where the signal does not exceed the operating range. This specification is the worst-case (slowest to fastest) over the specified range.
- Note 37: 0 to +1V input to comparator, VCMPV reference = +0.5V, input rise/fall time = 250ps.
- Note 38: Input to comparator is 40MHz at 0 to +1.0V, 50% duty cycle, 1ns rise/fall time.
- Note 39: Unless otherwise specified, comparator outputs are terminated with 50Ω to +1.2V and V_{CTV} = +1.2V.
- Note 40: While device is in low-leak mode, care must be taken to never present a voltage greater than V_{CC} to the DUT_ node, as this can damage the part.
- Note 41: At nominal supply voltages. Nominal values are V_{CC} = +9.25V, V_{EE} = -5.25V, and V_{VHH} = +17.5V. Production tests are performed with worst-case supply conditions for each specification. Supply conditions are either min V_{CC} and max V_{EE} or max V_{CC} and min V_{EE} . Some tests could require both conditions. Total current for device. $R_L \ge 10M\Omega$.
- Note 42: Increasing DGS beyond 0V requires a proportional increase in the minimum supply levels. Specified ranges for all levels are defined with respect to DGS.
- Note 43: Increasing DGS beyond 0V requires a proportional increase in the minimum supply levels. Limited range of -1.5V to +5.5V for all levels are defined with respect to DGS.

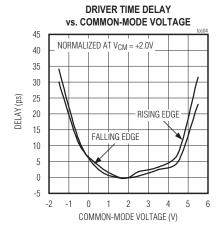
Typical Operating Characteristics

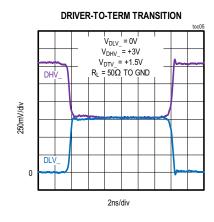
 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = GND, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included, T_J = +70°C, temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

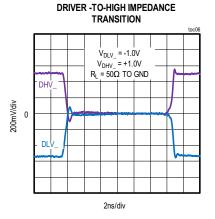






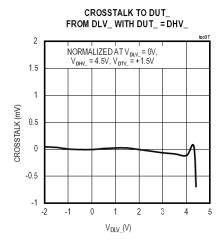


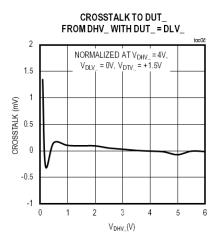


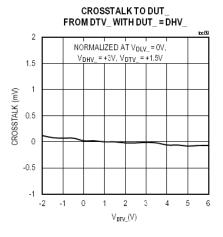


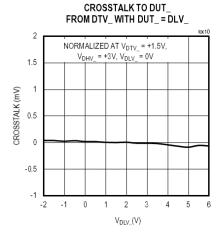
Typical Operating Characteristics (continued)

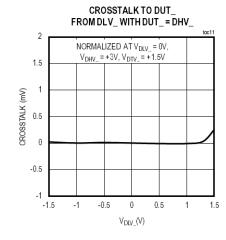
 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = GND, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included, T_J = +70°C, temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

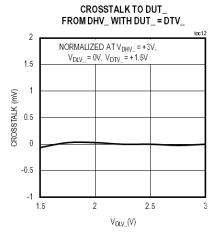






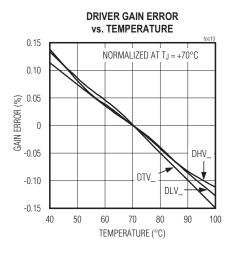


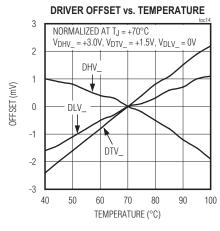


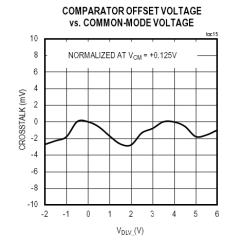


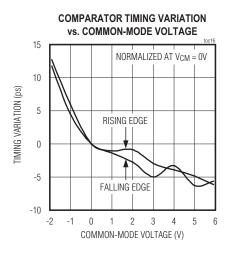
Typical Operating Characteristics (continued)

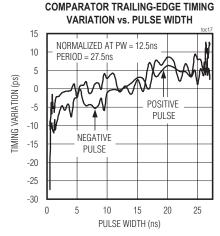
 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = GND, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included, T_J = +70°C, temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

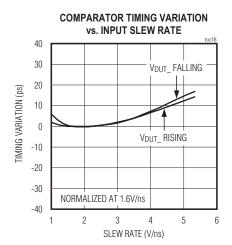






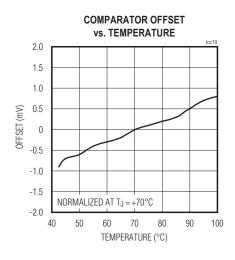


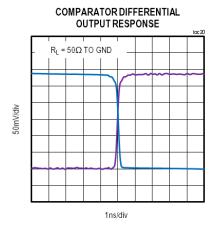


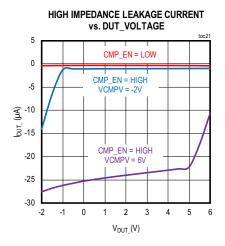


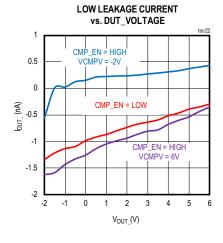
Typical Operating Characteristics (continued)

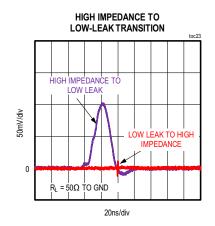
 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = GND, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included, T_J = +70°C, temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

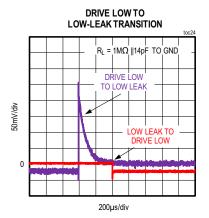






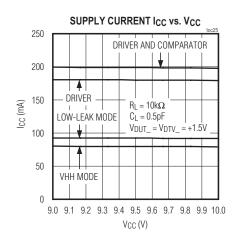


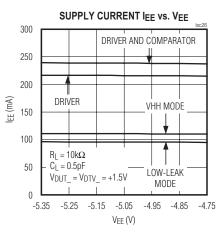


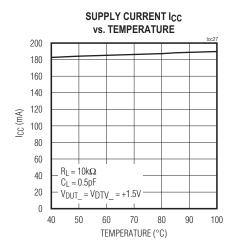


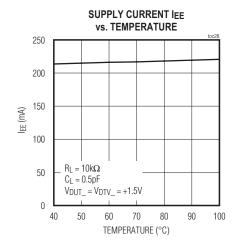
Typical Operating Characteristics (continued)

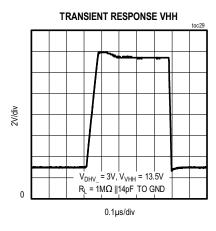
 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = GND, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included, T_J = +70°C, temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

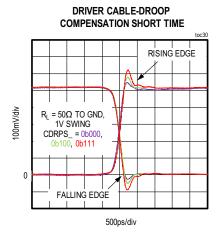






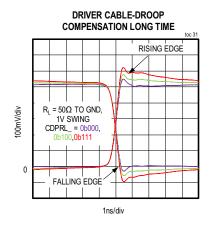


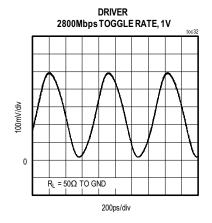


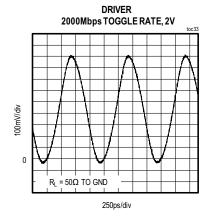


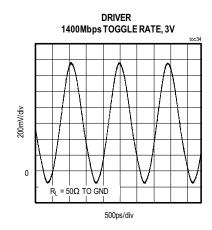
Typical Operating Characteristics (continued)

 $(V_{CC} = +9.25V, V_{EE} = -5.25V, V_{HHP} = +17.5V, V_{DD} = +3.3V, V_{DHV} = +3V, V_{DTV} = +1.5V, V_{DLV} = 0V, V_{DATV} = V_{RTV} = GND, V_{CTV} = +1.2V, V_{CMPV} = +1V, V_{VHH} = +10V, CDRP_ = 000b, RO_ = 1110b, SC = 00b, V_{DGS} = V_{GND} = V_{GNDDAC} = 0V, specifications apply after calibration, level-setter errors included, T_J = +70°C, temperature coefficients are measured at T_J = +40°C and +100°C, unless otherwise noted.)$

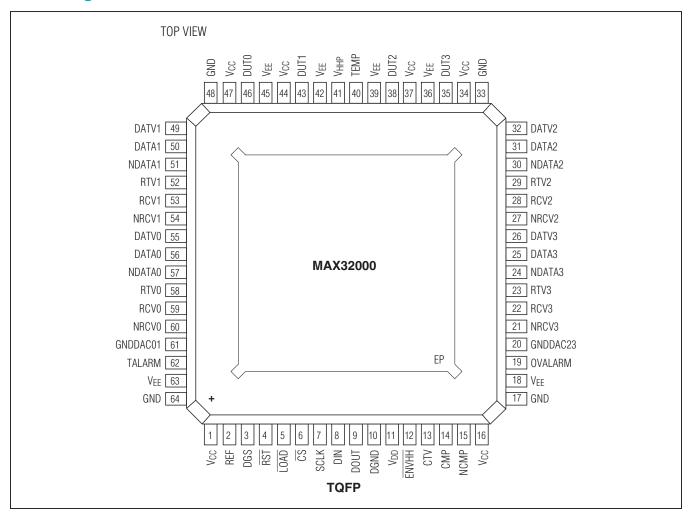








Pin Configuration



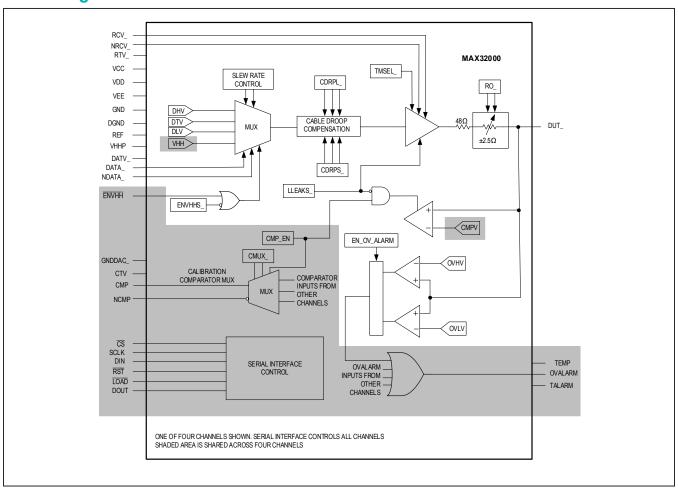
Pin Description

PIN	NAME	FUNCTION			
1, 16, 34, 37, 44, 47	Vcc	Positive Power Supply			
2	REF	DAC 2.5V Reference Input. Set REF with respect to GNDDAC			
3	DGS	Device Under Test Ground-Sense Input			
4	RST	Active-Low Serial-Port Reset Input			
5	LOAD	Active-Low Serial-Port Load Input			
6	CS	Active-Low Serial-Port Chip-Select Input			
7	SCLK	Serial-Port Clock Input			
8	DIN	Serial-Port Data Input			
9	DOUT	Serial-Port Data Output			
10	DGND	Digital Ground			
11	V_{DD}	Logic Power Supply			
12	ENVHH	Active-Low High-Voltage-Enable Input			
13	CTV	Comparator Termination Voltage			
14	CMP	Comparator Output			
15	NCMP	Comparator-Output Complement			
17, 33, 48, 64	GND	Analog Ground			
18, 36, 39, 42, 45, 63	VEE	Negative Power Supply			
19	OVALARM	Overvoltage Alarm Output			
20	GNDDAC23	Channels 2 and 3 DAC Ground			
21	NRCV3	Channel 3 Receive Input Complement			
22	RCV3	Channel 3 Receive Input			
23	RTV3	Channel 3 Receive Termination Voltage			
24	NDATA3	Channel 3 Data Input Complement			
25	DATA3	Channel 3 Data Input			
26	DATV3	Channel 3 Data Termination Voltage			
27	NRCV2	Channel 2 Receive Input Complement			
28	RCV2	Channel 2 Receive Input			
29	RTV2	Channel 2 Receive Termination Voltage			
30	NDATA2	Channel 2 Data Input Complement			
31	DATA2	Channel 2 Data Input			
32	DATV2	Channel 2 Data Termination Voltage			
35	DUT3	Channel 3 Input/Output			
38	DUT2	Channel 2 Input/Output			
40	TEMP	Temperature Sensor Output			
41	VHHP	High-Voltage Power Supply			
43	DUT1	Channel 1 Input/Output			
46	DUT0	Channel 0 Input/Output			
49	DATV1	Channel 1 Data Termination Voltage			
50	DATA1	Channel 1 Data Input			
51	NDATA1	Channel 1 Data Input Complement			

Pin Description (continued)

PIN	NAME	FUNCTION
52	RTV1	Channel 1 Receive Termination Voltage
53	RCV1	Channel 1 Receive Input
54	NRCV1	Channel 1 Receive Input Complement
55	DATV0	Channel 0 Data Termination Voltage
56	DATA0	Channel 0 Data Input
57	NDATA0	Channel 0 Data Input Complement
58	RTV0	Channel 0 Receive Termination Voltage
59	RCV0	Channel 0 Receive Input
60	NRCV0	Channel 0 Receive Input Complement
61	GNDDAC01	Channels 0 and 1 DAC Ground
62	TALARM	Temperature Alarm Output
_	EP	Exposed Pad. EP is internally connected to V _{EE} . Connect to V _{EE} or leave unconnected. Do not use EP as a primary connection to V _{EE} .

Block Diagram



Detailed Description

The MAX32000 quad-channel, pin-electronics driver integrates multiple pin-electronics functions into a single IC. Each channel includes a four-level pin driver, a shared calibration comparator, and five independent level-setting DACs (three 14-bit and two 8-bit). Additionally, each channel of the MAX32000 features programmable cable-droop compensation for the driver output, adjustable driver output resistance, and driver slew-rate adjustment.

The driver features a wide -2V to +6V high-speed operating range. In VHH mode, the output is from 0 to +13V. The MAX32000 also offers high-impedance and active-termination (3rd-level drive) modes, and is highly linear even at low-voltage swings. The driver provides high-speed differential control inputs compatible with most high-speed logic families. The calibration comparators provide extremely low timing variation over changes in slew rate, pulse width, or overdrive voltage, and provide 50Ω source outputs internally terminated to an applied voltage at CTV.

Independent low-leak control is provided for each channel. Placing the MAX32000 DUT_ output into a very low-leakage state disables the driver functions. An SPIK-compatible serial interface and external inputs configure the MAX32000.

Integrated PE Mode Selection

The MAX32000 features two modes of operation, active and low leak. The MAX32000 enters low-leak mode when the LLEAKS_ bit is set to 1. The serial bits LLEAKS_ = 1 can be used to force the QDRV register to low-leak mode independent of other control bits. Setting LLEAKS_ to 0 is necessary to allow any other mode of operation (see <u>Table 1</u>). For SPI register bit assignments, see <u>Table 9</u>.

Driver

The driver uses a high-speed multiplexer to select one of three DAC voltages (VDHV_, VDLV_, and VDTV_), high-impedance mode, or high-voltage mode (VHH). Multiplexer switching is controlled by high-speed differential inputs DATA_/NDATA_ and RCV_/NRCV_ and mode-control bits TMSEL_ and ENVHHS_ (see <u>Table 1</u>). The multiplexer output is buffered to drive DUT_. A programmable slew-rate circuit controls the slew rate of the buffer output.

In high-impedance mode, the comparator remains connected to DUT_, the DUT_ bias current is less than $\pm 50\mu A$, and the node continues to track high-speed signals. In low-leak mode, the bias current at DUT_ is further reduced to less than $\pm 100nA$, yet signal tracking slows down.

The nominal driver output resistance is 48Ω and features an adjustment range of $\pm 2.5\Omega$ through the serial interface in 360ml increments.

Table 1. Driver Functional Overview

LLEAKS_ (SPI BIT)	ENVHHS_* (SPI BIT)	ENVHH** (EXTERNAL PIN)	TMSEL_ (SPI BIT)	RCV_	DATA_	DRIVER OUTPUT
0	X	1	X	0	0	Drive to DLV_
0	X	1	X	0	1	Drive to DHV_
0	0	1	0	1	X	High-impedance receive
0	0	1	1	1	X	Drive to DTV_
0	1	X	X	1	X	Drive to VHH**
0	Х	0	X	Х	X	Drive to VHH**
1	Х	X	X	Х	Х	Low leak

X = Don't care.

Note: It is anticipated that the driver's VHH state is entered from one of the two drive states (DLV_ or DHV_) and not directly from the high-impedance or DTV_ states.

^{*}DHV_-to-DLV_ and DLV_-to-DHV_ transition times are not altered by the state of ENVHHS_.

^{**}Control of VHH is initiated either through the direct assertion of the ENVHH input, or in response to the assertion of the RCV_/ NRCV_ high-speed inputs when ENVHHS_ = 1 in the QDRV register.

Driver Slew Control

A slew-rate circuit controls the slew rate of the buffer output. Select one of four possible slew rates according to $\underline{Table\ 2}$. The speed of the internal multiplexer sets the 100% driver slew rate. SC1 and SC0 are set to 0 at power-up or when \overline{RST} is forced low.

Table 2. Driver Slew Control

SC1	SC0	DRIVER SLEW RATE (%)			
0	0	100			
0	1	75			
1	0	50			
1	1	25			

Driver Cable-Droop Compensation

The driver incorporates active cable-droop compensation (refer to Application Note 4338: <u>Cable-Loss Solutions</u>). At high frequencies, transmission-line effects from the tester signal delivery path (PCB trace, connectors, and cabling between the MAX32000 DUT_ output and the device under test itself) can degrade the output waveform fidelity at the DUT, resulting in a highly degraded or unusable signal. The compensation circuit counters this degradation by adding a double time-constant decaying waveform to the nominal output waveform (pre-emphasis). <u>Figure 1</u> shows a comparison between a typical driver and the MAX32000, and shows how droop compensation counters signal degradation. The maximum swing while maintaining the linear compensation of the driver cable droop is 4.4VP-P. There are long-time-constant (1.2ns) control

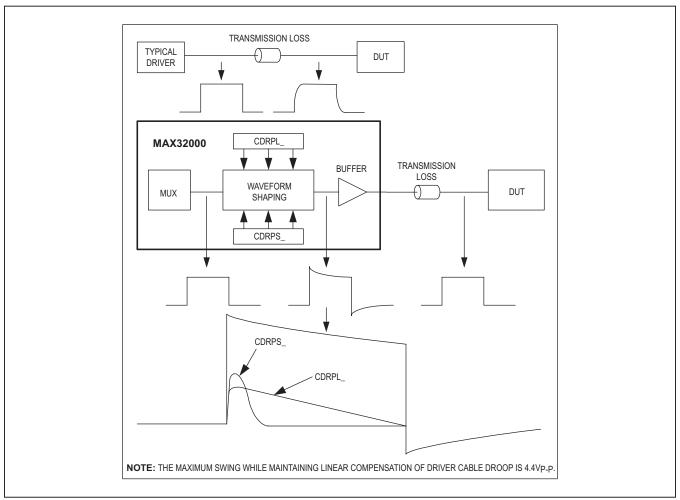


Figure 1. Driver Cable-Droop Compensation

bits, CDRPL[2:0], and short-time-constant (60ps) control bits, CDRPS[2:0], in the QDRV CAL register to set the amount of compensation. Control bits CDRP_[2:0] vary the amplitude of the compensation signal. $\underline{Table~3}$ and $\underline{Table~4}$ show the percent compensation as a function of control bit settings. The default power-on reset (POR) value of CDRP_[2:0] is 0b000 for zero compensation.

Table 3. Driver Cable-Droop Compensation Short-Time-Constant Control Logic

CDRPS2	CDRPS1	CDRPS0	DROOP COMPENSATION (%)
0	0	0	0.0
0	0	1	2.1
0	1	0	4.3
0	1	1	6.4
1	0	0	8.6
1	0	1	10.7
1	1	0	12.9
1	1	1	15.0

Table 4. Driver Cable-Droop Compensation Long-Time-Constant Control Logic

CDRPL2	CDRPL1	CDRPL0	DROOP COMPENSATION (%)
0	0	0	0.0
0	0	1	2.1
0	1	0	4.3
0	1	1	6.4
1	0	0	8.6
1	0	1	10.7
1	1	0	12.9
1	1	1	15.0

Adjustable Driver Output Impedance

The MAX32000 driver output impedance is adjustable to $\pm 2.5\Omega$ with a $360m\Omega$ resolution. The RO_ bits in the QDRV CAL register set the impedance value. <u>Table 5</u> shows the output-resistance control logic. The output resistance is set to RO_ + 0.0Ω (0b1000) at power-up.

VHH Function

VHH allows DUT_ to drive voltages up to +13V. The VHH DAC, which is shared among all four channels, adjusts from 0 to +13V. Although the primary VHH level is shared, there are independent offset and gain correction circuits for each channel. <u>Table 1</u> indicates the control settings required to set DUT_ to VHH. See the <u>Level Transfer Functions</u> section for the transfer function of the VHH DAC.

Set the ENVHH pin low or set the ENVHHS_ serial bit to 1 to enable VHH mode. See *Table 1*.

Table 5. Driver Delta Ro Control

RO3	RO2	RO1	RO0	DRIVER OUTPUT RESISTANCE (Ω)
0	0	0	0	R _O - 2.88
0	0	0	1	R _O - 2.52
0	0	1	0	R _O - 2.16
0	0	1	1	Ro - 1.80
0	1	0	0	R _O - 1.44
0	1	0	1	Ro - 1.08
0	1	1	0	R _O - 0.72
0	1	1	1	Ro - 0.36
1	0	0	0	Ro + 0.0
1	0	0	1	Ro + 0.36
1	0	1	0	R _O + 0.72
1	0	1	1	Ro + 1.08
1	1	0	0	R _O + 1.44
1	1	0	1	R _O + 1.80
1	1	1	0	R _O + 2.16
1	1	1	1	R _O + 2.52

Table 6. Calibration Comparator Control

CMP_EN	LLEAKS3	LLEAKS2	LLEAKS1	LLEAKS0	CMUX1	CMUX0	DRIVER SELECTED
1	X	X	X	0	0	0	CH0
1	X	X	0	X	0	1	CH1
1	X	0	Х	Х	1	0	CH2
1	0	X	X	Х	1	1	CH3
1	1	1	1	1	Х	Х	*
0	Х	Х	Х	Х	Х	Х	*

X = Don't care.

Calibration Comparator

Set serial bit CMP_EN = 1 to enable the comparator function. The drive channel selected by the CMUX_ and LLEAKS_ bits is presented to the high-speed comparator outputs as shown in <u>Table 6</u>.

Serial Interface

An SPI-compatible serial interface controls the MAX32000. The serial interface, detailed in <u>Figure 2</u>, operates with clock speeds up to 50MHz and includes the signals $\overline{\text{CS}}$, SCLK, DIN, $\overline{\text{RST}}$, $\overline{\text{LOAD}}$, and DOUT. Serial-interface timing is shown in <u>Figure 3</u> and timing specifications are detailed in the <u>Electrical Characteristics</u> table.

Loading Data into the MAX32000

Load data into the 24-bit shift register from DIN on the rising edge of SCLK, while $\overline{\text{CS}}$ is low (Figure 2). Send the address and data bits MSB first to LSB. The MAX32000 is updated when the control and level-setting data are latched into the control and level-setting registers. The control and level-setting registers are separated from the shift register by the input and channel-select registers. Two methods allow for data to transfer from the shift register to the control and level-setting registers, depending on the state of external digital input $\overline{\text{LOAD}}$.

Holding $\overline{\text{LOAD}}$ high during the rising edge of $\overline{\text{CS}}$ allows the shift register data to transfer only into the input and channel-select registers. Force $\overline{\text{LOAD}}$ low to transfer the data into the control and level-setting registers. Changes update on the falling edge of $\overline{\text{LOAD}}$, which allows preloading of data and facilitates synchronizing updates across multiple devices. See *Figure 3* and *Figure 4*.

Holding $\overline{\text{LOAD}}$ low during the rising edge of $\overline{\text{CS}}$ forces the input and channel-select registers to become transparent and all data transfers through these registers directly to the control and level-setting registers. Changes update on the rising edge of $\overline{\text{CS}}$. Figure 4 and Figure 5 show how $\overline{\text{LOAD}}$ and $\overline{\text{CS}}$ function, and also the data configuration of SCLK, DIN, and DOUT. The calibration registers change on the rising edge of $\overline{\text{CS}}$, regardless of the state of $\overline{\text{LOAD}}$.

Serial-Port Timing

Timing and arrangement of the serial-port signals are shown in *Figure 3*, *Figure 4*, and *Figure 5*.

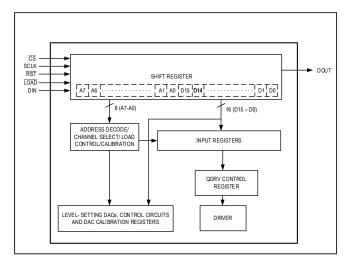


Figure 2. Serial-Interface Block Diagram

^{*}Comp output fixed. CMP = high and NCMP = low.

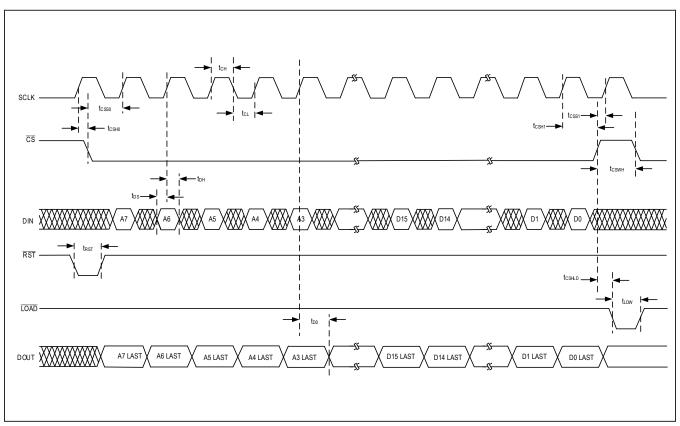


Figure 3. Detailed Serial-Port Timing Diagram

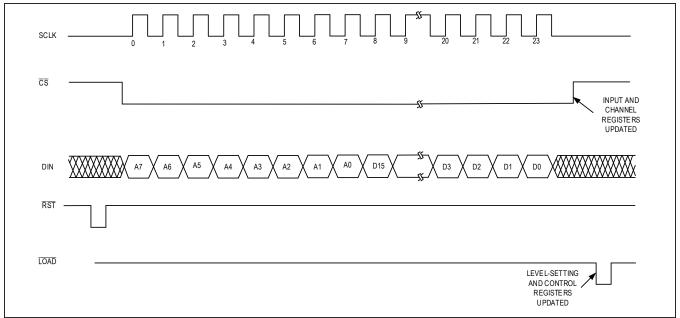


Figure 4. Serial-Port Timing with Asynchronous Load

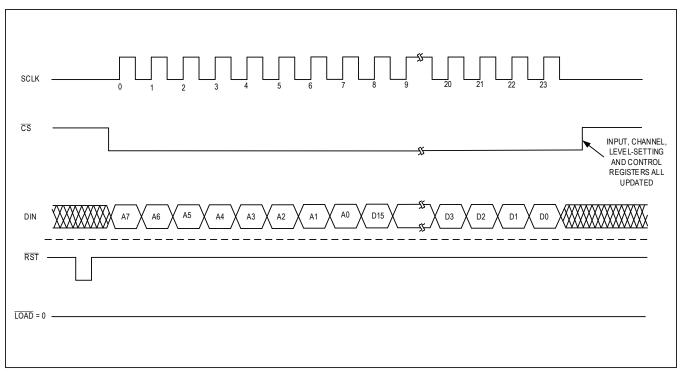


Figure 5. Serial-Port Timing with Synchronous Load

Serial Interface DOUT

DOUT is a buffered version of the last bit in the serial-interface shift register. The complete contents of the shift register can be read at DOUT during the next write cycle. To shift data out without modifying any registers, perform a write with address bits A[7:0] = 0x08. Use DOUT to daisy-chain multiple devices, and/or to verify that data was properly shifted in during the previous communication. Data is shifted into the shift register on the rising edge of the SCLK, when $\overline{\text{CS}}$ is low. The shift register is 24 bits long.

Device Control

Control and level-setting registers are selected to receive data based on the channel and mode-select bits A[7:0]. <u>Table 9</u> and <u>Table 10</u> show the control register bits and functions. Level-setting DAC data and control register data are contained in the 16 data bits D[15:0]. <u>Table 7</u>,

<u>Table 8</u>, and <u>Table 9</u> detail the bit functions. Clock in bit A7 first and bit D0 last, as shown in <u>Figure 3</u>.

Bit A7 allows access to the DAC calibration registers. Use the calibration registers to adjust the gain and offset of each DAC. Set bit A7 to write to the calibration registers. See the <u>Level-Setter DAC and Calibration Addresses</u> section for more information.

Table 7. Serial-Interface Control Bits

DIN	FUNCTION			
A7	Calibration register write			
A6*	Broadcast enable			
A[5:4]	Channel address			
A[3:0]	Register address			
D[15:0]	Register data			

*All channels are written when the broadcast enable bit (A6) is set high and bits A[5:4] are set low.

Register Address Table

Table 8. Serial-Interface Register Addresses

	ADDR	RESS*		REGI	STER
А3	A2	A1	A0	A7 = 0, A4 AND A5 = CH	A7 = 1, A4 AND A5 = CH
0	0	0	0	QDRV	QDRV CAL
0	0	0	1	DHV_	DHV_CAL
0	0	1	0	DLV_	DLV_CAL
0	0	1	1	DTV_	DTV_CAL
0	1	0	0	TS (CH0 only)	_
1	0	1	1	CMPV (CH0 only)	CMPV CAL
1	1	0	0	VHH (CH0 only)	VHH CAL
1	1	0	1	OVHV	_
1	1	1	0	OVLV	_
1	1	1	1	CMP (CH0 only)	_

^{*}The addresses from 0b0101 to 0b1010 are not allowed.

Data Bit Assignments

Table 9. Serial-Interface Data Bit Assignments

REGISTER	Α	DDRE	ESS (Note	1)							DATA	(Note	s 1, 2)							POR
NAME	ALL	СНЗ	CH2	CH1	CH0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	VALUE
QDRV	0x40	0x30	0x20	0x10	0x00	ı	1	-	1	1	EN_TEMP_ ALARM _ (Note 3)	EN_OV_ ALARM	I	-	I	_	ENVHHS_	TMSEL	LLEAKS_	SC1	SC0	0x004
DHV_	0x41	0x31	0x21	0x11	0x01	1	I	DLVL13	DLVL12	DLVL11	DLVL10	DLVL09	DLVL08	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x1333
DLV_	0x42	0x32	0x22	0x12	0x02		I	DLVL13	DLVL12	DLVL11	DLVL10	DLVL09	DLVL08	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x1333
DTV_	0x43	0x33	0x23	0x13	0x03		I	DLVL13	DLVL12	DLVL11	DLVL10	DLVL09	DLVL08	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x1333
TS	0x44				0x04		1	I	1		I	I	I		TSMUX0			1		I	1	0x0000

Table 9. Serial-Interface Data Bit Assignments (continued)

REGISTER	Α	DDRE	ESS (Note	1)							DATA	(Note	es 1, 2	2)							POR
NAME	ALL	СНЗ	CH2	CH1	СН0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	VALUE
CMPV	0x4B	I	_	I	0x0B		_	DLVL13	DLVL12	DLVL11	DLVL10	DLVL09	DLVL08	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x1333
VHH	0x4C	I	1	1	0x0C	1	1	DLVL13	DLVL12	DLVL11	DLVL10	DLVL09	DLVL08	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x1333
OVHV	0x4D	0x3D	0x2D	0x1D	0x0D		I	ı	ı	1	I	ı	-	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x4D
OVLV	0x4E	0x3E	0x2E	0x1E	0x0E	-	ı	ı	ı	_		1	_	DLVL07	DLVL06	DLVL05	DLVL04	DLVL03	DLVL02	DLVL01	DLVL00	0x4D
CMP	0x4F	1		ı	0x0F		ı	ı	ı	1		ı	_	I	1	I	I	ı	CMP_EN	CMUX1	CMUX0	0x0000
QDRV CAL (Note 4)	0xC0	0xB0	0xA0	0x90	0x80		I	I	I	1		CDRPL2	CDRPL1	CDRPL0	CDRPS2	CDRPS1	CDRPS0	RO3	RO2	RO1	RO0	0x0000
DHV_ CAL (Note 4)	0xC1	0xB1	0xA1	0x91	0x81	1	ı	GCAL5	GCAL4	GCAL3	GCAL2	GCAL1	GCAL0	OCAL7	OCAL6	OCAL5	OCAL4	OCAL3	OCAL2	OCAL1	OCAL0	0x2080
DLV_ CAL (Note 4)	0xC2	0xB2	0xA2	0x92	0x82		I	GCAL5	GCAL4	GCAL3	GCAL2	GCAL1	GCAL0	OCAL7	OCAL6	OCAL5	OCAL4	OCAL3	OCAL2	OCAL1	OCAL0	0x2080
DTV_ CAL (Note 4)	0xC3	0xB3	0xA3	0x93	0x83		I	GCAL5	GCAL4	GCAL3	GCAL2	GCAL1	GCAL0	OCAL7	OCAL6	OCAL5	OCAL4	OCAL3	OCAL2	OCAL1	OCAL0	0x2080
CMPV CAL (Note 4)	0xCB	0xBB	0xAB	0x9B	0x8B		I	GCAL5	GCAL4	GCAL3	GCAL2	GCAL1	GCAL0	OCAL7	OCAL6	OCAL5	OCAL4	OCAL3	OCAL2	OCAL1	OCAL0	0x2080
VHH CAL (Note 4)	0xCC	0xBC	0xAC	0x9C	0x8C		ı	GCAL5	GCAL4	GCAL3	GCAL2	GCAL1	GCAL0	OCAL7	OCAL6	OCAL5	OCAL4	OCAL3	OCAL2	OCAL1	OCAL0	0x2080

Note 1: Em dashes (—) in the register bit table represent an unused register bit set to 0.

Note 2: The data bits enter the shift register in the order D[15:0].

Note 3: The EN_TEMP_ALARM bit is in the CH0 QDRV register only.

Note 4: Level-setter calibration registers and QDRV calibration registers reset only through an internally generated POR signal.

Level-Setter DAC and Calibration Addresses

The MAX32000 contains a total of 22 DACs to generate the DC voltage levels for the various control and monitoring circuits of the 4-channel MAX32000, a total of five levels per channel, plus two shared levels. All channels share a common DAC for the CMPV and VHH; however, each channel includes independent gain and offset adjustment for CMPV and VHH. All DAC levels, with the exception of OVHV and OVLV, are set by a 14-bit code value that varies between a hex value of 0x0000 and 0x3FFF. OVHV and OVLV are set using an 8-bit code that varies between 0x00 and 0xFF.

Table 10, Table 11, and Table 12 identify the serial-interface address of each DAC and the address of the associ-

ated calibration register. Registers can be addressed by individual channel or by utilizing a broadcast address that accesses all channels simultaneously. The level-setter output block diagram is shown in *Figure 6*.

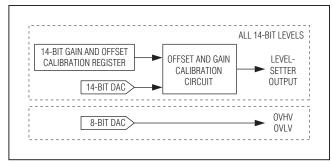


Figure 6. Level-Setter Block Diagrams

Table 10. Level-Setter DAC Addressing Table

	1 57/51	DAC REGISTER									
LEVEL NAME	LEVEL DESCRIPTION		ADDRESS								
	DESCRIPTION	CH0	CH1	CH2	CH3	ALL	VALUE*				
DHV_	Driver high	0x01	0x11	0x21	0x31	0x41	0x1333				
DLV_	Driver low	0x02	0x12	0x22	0x32	0x42	0x1333				
DTV_	Driver term	0x03	0x13	0x23	0x33	0x43	0x1333				
CMPV**	Comparator threshold	0x0B	_	_	_	_	0x1333				
VHH**	Driver very high voltage	0x0C	_	_	_	_	0x1333				
OVHV	Overvoltage-detect high	0x0D	0x1D	0x2D	0x3D	0x4D	0x4D				
OVLV	Overvoltage-detect low	0x0E	0x1E	0x2E	0x3E	0x4E	0x4D				

^{*}These values are reset during a POR or with the assertion of the RST pin.

Table 11. Level-Setter DAC Calibration Address Table

1.57/51	1 5/51	CALIBRATION REGISTER								
NAME	LEVEL DESCRIPTION		ADDRESS							
	DESCRIPTION	CH0	CH1	CH2	CH3	ALL	VALUE*			
DHV_	Driver high	0x81	0x91	0xA1	0xB1	0xC1	0x2080			
DLV_	Driver low	0x82	0x92	0xA2	0xB2	0xC2	0x2080			
DTV_	Driver term	0x83	0x93	0xA3	0xB3	0xC3	0x2080			
CMPV**	Comparator threshold	0x8B	0x9B	0xAB	0xBB	0xCB	0x2080			
VHH**	Driver very high voltage	0x8C	0x9C	0xAC	0xBC	0xCC	0x2080			

^{*}These values are only reset during a POR. Thus, the device can be reset to a known state without requiring the reprogramming of calibration registers.

^{**}The VHH and CMPV levels are shared among channels 0-3. Each channel has independent calibration registers.

^{**}The VHH and CMPV levels are shared among channels 0–3. Each channel has independent calibration registers.

Table 12. Comparator Control Address Table

LEVEL NAME	LEVEL	COMMON CONTROL REGISTER							
	LEVEL DESCRIPTION		ADDRESS						
	DESCRIPTION	CH0	CH1	CH2	CH3	ALL	VALUE**		
CMP*	Calibration comparator mux register	0x0F	_	_	_	_	0x0000		

^{*}This register controls the common calibration multiplexer.

Level-Setter Calibration Registers—Gain and Offset Codes

DAC calibration registers adjust the gain and offset of each DAC. Each DAC includes one or more calibration registers. All DAC calibration registers are programmed with a 14-bit code (Table 9). The codes are divided into two fields, one field each for gain (GCAL) and offset (OCAL). All DACs provide a 6-bit field for gain and an 8-bit field for offset.

Calibration registers are reset to default values only during a POR. Asserting the RST does not force the calibration registers to default values.

Level Transfer Functions

Each of the MAX32000 analog DAC levels except OVHV and OVLV is set with a transfer function that includes the 14-bit DAC code setting, the gain code setting, and the offset code setting. The VDAC expressions below present the basic DAC transfer function. Each DAC provides a voltage output range of -3.0V to +7.0V (typ). There are five of these DACs per channel, and an additional two DACs that are shared among all channels. Each DAC is identical and generates a potential according to the equation that follows.

The transfer function for the 14-bit DACs (DHV_, DLV_, DTV, CMPV, and VHH) is:

where Vg = VgNDDAC - VDGS

The transfer function for the 8-bit DACs (OVHV and OVLV) is:

where Vg = VgNDDAC - VDGS

For all DACs, the offset code is an integer value between 0 and 255, and the gain code is an integer value between 0 and 63. Offset and gain codes are based on the calibration register settings (Table 13).

Each channel has individual offset and gain correction for the commonly shared VHH and CMPV DACs.

Table 13. Level-Setter Transfer Functions

LEVEL	LEVEL TRANSFER FUNCTION
DHV_	V _{DAC14} x DHV_gain + DHV_offset
DLV_	VDAC14 x DLV_gain + DLV_offset
DTV_	V _{DAC14} x DTV_gain + DTV_offset
CMPV	VDAC14 x CMPVgain + CMPVoffset
VHH	(VDAC - VDGS) x 2 x VHH gain + VHH offset + VDGS
OVHV	VDAC8
OVLV	VDAC8

Applications

Device Power-Up State

Upon power-up, the MAX32000 enters low-leak mode; the QDRV register defaults to 0x0004, the level and calibration registers default to 0x1333 and 0x2080, respectively, and OVLV and OVHV are set to 0x4D. For initial power-up values for the levels, see Table 10, Table 11, and Table 12. Power supplies can be powered in any sequence.

Alarms

The MAX32000 features two fault-condition alarms. The first is a temperature sense alarm that activates when the MAX32000 internal temperature exceeds +125°C. The second fault condition activates when the voltage on DUT falls outside programmable voltage levels, higher than OVHV or below OVLV. The OVHV and OVLV levels are set by internal 8-bit DACs. Each channel features individual overvoltage-enable alarm bits, EN_OV_ALARM, in the QDRV register. A shared temperature-sense alarmenable bit is in the QDRV register of channel 0 (see Table 9 for the register map). A binary 1 must be programmed into those enable bits for the monitor circuits to assert their respective alarm outputs (TALARM, OVALARM). Alarm outputs are active low, open drain, and referenced to DGND. It is anticipated that the user implements the latch function in the ASIC/FPGA that monitors the TALARM signal. The overvoltage alarm is disabled when the driver is selected to VHH, because in most cases, VHH exceeds OVHV.

^{**}These values are reset during a POR or with the assertion of the $\overline{\mathsf{RST}}$ pin.

Temperature Sensor

The MAX32000 provides a temperature sensor. The temperature-sensor function is enabled utilizing the TSMUX0 bit in the TS register. Contents of the TS register can be modified through the serial interface. <u>Table 14</u> defines the bit code necessary to enable this function. The temperature-sensor output is an analog voltage with +3.43V representing TJ = +70°C and varies at ± 10 mV/°C.

Power-Supply Considerations

Bypass each supply input to GND and REF to DGS with $0.1\mu F$ capacitors. Additionally, use bulk bypassing $\geq 10\mu F$ where the power-supply connections meet the circuit board.

Exposed Pad

The exposed pad (EP) is internally connected to VEE. Connect to VEE or leave unconnected. Do not use the EP as the primary connection to VEE. Connect the EP to a large plane or heat sink to maximize thermal performance.

Warning: Do not connect EP to ground.

Level-Setter Output Programming

For DHV_, DLV_, DTV_, and CMPV, the DAC output voltage is nominally:

(VREF x code/4096) - 3 + VDGS

where VREF is nominally 2.500V.

The gain DAC pivot point is 1.0V.

For VHH, the DAC output voltage is nominally:

2 x ((VREF x code/4096) - 3) + VDGS

The gain DAC pivot point is 2.0V.

VREF is a precision +2.500V reference.

Table 14. Temp Sensor Control

TSMUX0	TEMP PIN OUTPUT
0	High impedance
1	Temperature-sensor voltage

To program a given voltage (V_{DACx}) for the 14-bit DAC, the voltage to code conversion is:

The DAC power-up default is 0x1333 (0V nominal).

The DAC RST default is 0x1333 (0V nominal).

The DAC has 14 bits of resolution. For DAC code settings that result in V_{DACx} output values that exceed the device specifications, the outputs roughly max out at the device range specification. For example, if DHV_ is programmed to code 16383 (7.5V), the driver outputs about 6.25V. More accurately, an internal diode begins to conduct, and the limiting is soft.

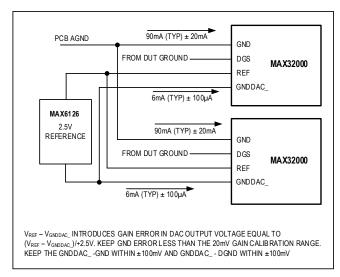


Figure 7. Sample Connection Diagram for Two Parts per Board

Calibration

After mathematically determining the calibration values, shown in <u>Table 15</u> and <u>Table 16</u>, the calibrated levels need to be checked and potentially adjusted up or down because the DAC gain and offset calibration registers have a nonlinear response that could result in the gain or offset values being off by as much as Q3 LSBs, based on mathematical calculations from endpoint measurements during calibration.

Calibration Algorithm

The user can perform a system calibration by overwriting the default values in the gain and offset registers for any DAC level. The DAC calibration points are shown in *Table 17*.

The DAC calibration algorithm is as follows:

- 1) Set the offset DAC to midpoint (1000 0000 = 0V nominal).
- 2) Set the level DAC to gain point 1 (GP1).
- 3) Set the gain DAC code to minimum = 00 0000.
- 4) Measure the output and call it VGAINMINGP1.
- 5) Set the gain DAC code to maximum = 11 1111.
- 6) Measure the output and call it VGAINMAXGP1.
- 7) Set the level DAC to gain point 2 (GP2).

- 8) Set the gain DAC code to minimum = 00 0000.
- 9) Measure the output and call it VGAINMINGP2.
- 10) Set the gain DAC code to maximum = 11 1111.
- 11) Measure the output and call it VGAINMAXGP2.
- 12) Calculate the gain code.

The DAC is not 0V based, so there are gain differences at 0V and at 3V.

For 63 codes, calculate the average range:

Calculated gain code = (1 - GAINMIN)/LSB. Call it GCALC.

13) For gain DAC codes of GCALC - 2 to GCALC + 2, measure the gain (VGP2 - VGP1)/(GP2 - GP1) at each code, where VGP_ is the output at level DAC code GP_.

Table 15. Offset Calibration Register

CODE	OFFSET VALUE	NOMINAL OFFSET (mV)
11111111	+FS/2 - 1 LSB	+100
•	•	•
•	•	•
•	•	•
10000001	+1 LSB	_
10000000	0	0
01111111	-1 LSB	_
•	•	•
•	•	•
•	•	•
00000000	-FS/2	-100

Table 16. Gain Calibration Register

CODE	OFFSET VALUE	NOMINAL GAIN (V/V)
111111	+FS/2 – 1 LSB	1.02
•	•	•
•	•	•
•	•	•
100001	+1 LSB	_
100000	0	1
011111	-1 LSB	_
•	•	•
•	•	•
•	•	•
000000	-FS/2	0.98

Table 17. Calibration Points

DAC	GAIN POINT 1 (V) (CODE)	GAIN POINT 2 (V) (CODE)	OFFSET POINT (V) (CODE)	CONDITION
DHV_	0.125 (0x1400)	3.875 (0x2C00)	0.125 (0x1400)	V _{DLV} _ = -2V, V _{DTV} _ = +1.5V
DLV_	0.125 (0x1400)	3.875 (0x2C00)	0.125 (0x1400)	V _{DHV} = +6V, V _{DTV} = +1.5V
DTV_	0.125 (0x1400)	3.875 (0x2C00)	0.125 (0x1400)	V _{DLV} _ = -2V, V _{DHV} _ = +6V
CMPV	0.125 (0x1400)	3.875 (0x2C00)	0.125 (0x1400)	_
VHH	7.75 (0x2C00)	12.75 (0x3C00)	7.75 (0x2C00)	_

MAX32000

High-Speed Quad Driver with Integrated DACs, Cable-Droop Compensation, Slew-Rate Control, and VHH Fourth-Level Drive

- 14) From codes GCALC 2 to GCALC + 2, choose the code that yields a gain closest to 1.0 and program the gain DAC to that code.
- 15) Set the level DAC to the offset point (OP).
- 16) Set the offset DAC code to minimum = 0000 0000.
- 17) Measure the output and call it VOFFSMIN.
- 18) Set the offset DAC code to maximum = 1111 1111.
- 19) Measure the output and call it VOFFSMAX.
- 20) Calculate the offset code:

Calculated offset code = (OP - VOFFSMIN)/LSB. Call it OCALC.

- 21) For offset DAC codes of OCALC 2 to OCALC + 2, measure the offset (Vop OP) at each code, where Vop is the output at level DAC code OP.
- 22) From codes OCALC 2 to OCALC + 2, choose the code that yields an offset closest to the desired value and program the offset DAC to that code.
- 23) The DAC should now be calibrated.

Calibration Example

The following is a calibration example for a DHV_ driver output high level:

- 1) With DHV_ = +0.125V, VGAINMINGP1 = +0.1600V and VGAINMAXGP1 = +0.084851V.
- 2) With DHV_ = +3.875V, VGAINMINGP2 = +3.8239V and VGAINMAXGP2 = +3.9246V.
- 3) GAINMIN = (3.8239V 0.1600V)/(3.875V 0.125V) = 0.97704.

- 4) GAINMAX = (3.9246V 0.084851V)/(3.875V 0.125V) = 1.023933.
- 5) GAINRANGE = 1.023933 0.97704 = 0.046893.
- 6) LSB = GAINRANGE/63 = 0.000744.
- 7) Gain code = (1 0.97704)/0.000744 = 31.
- 8) Remeasured +0.125V output at gain codes 29, 30, 31, 32, and 33 = +0.127601V, +0.127091V, +0.126848V, +0.126473V, and +0.126098V.
- 9) Remeasured +3.875V output at gain codes 29, 30, 31, 32, and 33 = +3.876120V, +3.876615V, +3.877110V, +3.877605V, and +3.878100V.
- 10) Gains at codes 29, 30, 31, 32, and 33 are +0.999605, +0.999837, +1.000070, +1.000302, and +1.000534.
- 11) Adjusted gain code = 31 (the closest to 1.0).
- 12) Program the gain DAC to code 31.
- 13) Set V_{DHV} = +0.125V, $V_{OFFSMIN}$ = +0.0269V, and $V_{OFFSMAX}$ = +0.2180V.
- 14) Calculate the offset code:

OFFSRANGE = V_{OFFSMAX} - V_{OFFSMIN} = +0.2180V - 0.0269V = +0.1911V.

LSB = OFFSRANGE/255 = + 0.000749V.

Calculated offset code = (0.125V - VOFFSMIN)/LSB = 131.

- 15) Offsets at codes 129, 130, 131, 132, and 133 are +0.1222V, +0.1230V, +0.1237V, +0.1245V, and +0.1252V.
- 16) Adjusted offset code = 133 (the closest to +0.125V).
- 17) Program adjusted offset code.
- 18) DHV_ should now be calibrated.

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
64 TQFP-EPR	C64E+9R	21-0162	

MAX32000

High-Speed Quad Driver with Integrated DACs, Cable-Droop Compensation, Slew-Rate Control, and VHH Fourth-Level Drive

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	11/19	Initial release	_
0.1	_	Fixed broken links in Package Information table	35
0.2	_	Fixed figure/table links	24, 26, 28, 31
1	1/21	Modified Block Diagram	22

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Specialty Function Logic category:

Click to view products by Maxim manufacturer:

Other Similar products are found below:

 SN74LVTH18514DGGR
 HMC706LC3C
 MC14490DWG
 MST2219KC
 CD4007UBE
 CD4007UBM
 SN74ABT18245ADL

 SN74ABT18245ADLR
 SN74ABT18640DL
 SN74ABT8543DL
 SN74ABT8543DW
 SN74ABT8646DL
 SN74ABT8646DW

 SN74ABT8652DL
 SN74ABTH182502APM
 SN74ABTH18504APM
 SN74ABTH18646APM
 SN74ACT1071DR

 SN74ACT1073DW
 SN74ACT1073DWR
 SN74BCT8245ADWR
 SN74ACT8990FN
 SN74ACT8997DW
 SN74BCT8244ADW

 SN74BCT8245ADW
 SN74BCT8374ADW
 BR262W26A103E1G
 SN74ABT8245DWG4
 CD4007UBEE4
 CD4007UBM96
 CD4007UBM96
 CD4007UBM96
 CD4007UBM96
 CD4007UBM9
 SN74LVT8996PW
 SN74LVT8996PWR
 SN74LVTH182502APM
 SN74LVTH18502APM
 SN74LVTH18504APM

 SN74LVTH18512DGGR
 SN74LVTH18512DGGR
 SN74LVTH18502APM
 SN74LVTH18504APM
 SN74LVTH18504APM